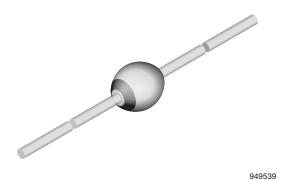


Vishay Semiconductors

Fast Avalanche Sinterglass Diode



FEATURES

- · Glass passivated junction
- · Hermetically sealed package
- Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

• High voltage fast rectification diode

MECHANICAL DATA

Case: SOD-57

Terminals: plated axial leads, solderable per MIL-STD-750,

method 2026

Polarity: color band denotes cathode end

Mounting position: any **Weight:** approx. 369 mg

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|--|----------------------------|--------|--|--|--|
| DEVICE NAME | NAME ORDERING CODE TAPED UNITS MINIMUM ORDER Q | | | | | |
| BY269 | BY269TR | 5000 per 10" tape and reel | 25 000 | | | |
| BY269 | BY269TAP | 5000 per ammopack | 25 000 | | | |

| PARTS TABLE | | | | | | |
|-------------|---|---------|--|--|--|--|
| PART | TYPE DIFFERENTIATION | PACKAGE | | | | |
| BY268 | $V_R = 1400 \text{ V}; I_{F(AV)} = 0.8 \text{ A}$ | SOD-57 | | | | |
| BY269 | $V_R = 1600 \text{ V}; I_{F(AV)} = 0.8 \text{ A}$ | SOD-57 | | | | |

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|--|--|-------|--------------------|---------------|------|--|
| PARAMETER | TEST CONDITION | PART | SYMBOL | VALUE | UNIT | |
| Peak reverse voltage, non repetitive | | BY268 | V_{RSM} | 1600 | V | |
| reak reverse voltage, non repetitive | | BY269 | V_{RSM} | 1800 | V | |
| Reverse voltage | See electrical characteristics | BY268 | V_R | 1400 | V | |
| neverse voitage | See electrical characteristics | BY269 | V_R | 1600 | V | |
| Peak forward surge current | $t_p = 10 \text{ ms}$, half sine wave | | I _{FSM} | 20 | Α | |
| Average forward current | | | I _{F(AV)} | 0.8 | Α | |
| Non repetitive reverse avalanche energy | I _{(BR)R} = 0.4 A | | E _R | 10 | mJ | |
| Junction and storage temperature range | | | $T_j = T_{stg}$ | - 55 to + 175 | °C | |

| MAXIMUM THERMAL RESISTANCE (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|--|-------------------|-------|------|--|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | | |
| Junction ambient | Lead length I = 10 mm, T _L = constant | R _{thJA} | 45 | K/W | | |
| Junction ambient | On PC board with spacing 25 mm | R _{thJA} | 100 | K/W | | |



Vishay Semiconductors

| ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | | |
|--|---|-------|-----------------|------|------|------|------|
| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | I _F = 0.4 A | | V_{F} | - | - | 1.25 | V |
| | V _R = 1400 V | BY268 | I _R | - | 1 | 2 | μΑ |
| Reverse current | V _R = 1600 V | BY269 | I _R | - | 1 | 2 | μΑ |
| neverse current | V _R = 1400 V, T _j = 100 °C | BY268 | I _R | - | - | 15 | μΑ |
| | V _R = 1600 V, T _j = 100 °C | BY269 | I _R | - | - | 15 | μΑ |
| Reverse recovery time | I _F = 0.5 A, I _R = 1 A, i _R = 0.25 A | | t _{rr} | - | - | 400 | ns |

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

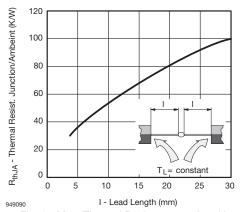


Fig. 1 - Max. Thermal Resistance vs. Lead Length

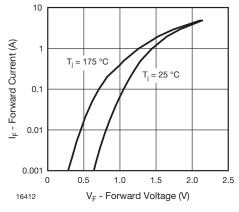


Fig. 2 - Max. Forward Current vs. Forward Voltage

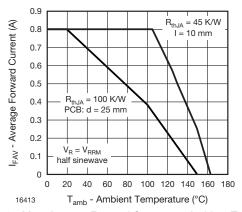


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

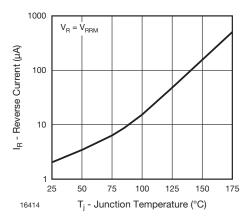


Fig. 4 - Max. Reverse Current vs. Junction Temperature



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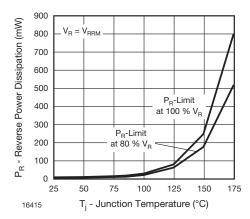


Fig. 5 - Max. Reverse Power Dissipation vs. Junction Temperature

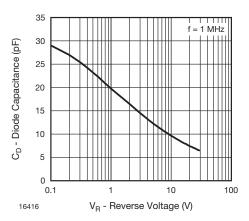
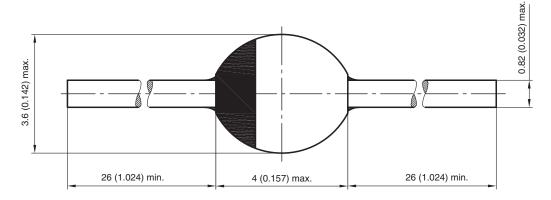


Fig. 6 - Diode Capacitance vs. Reverse Voltage

PACKAGE DIMENSIONS in millimeters (inches): SOD-57



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